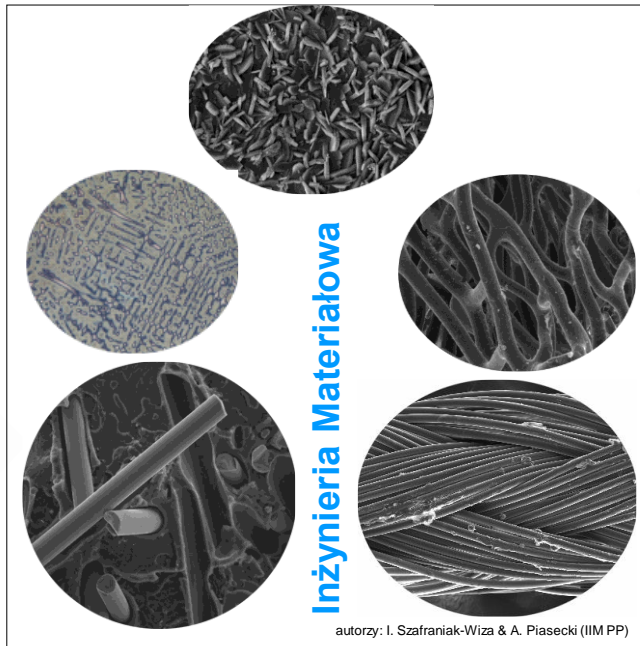
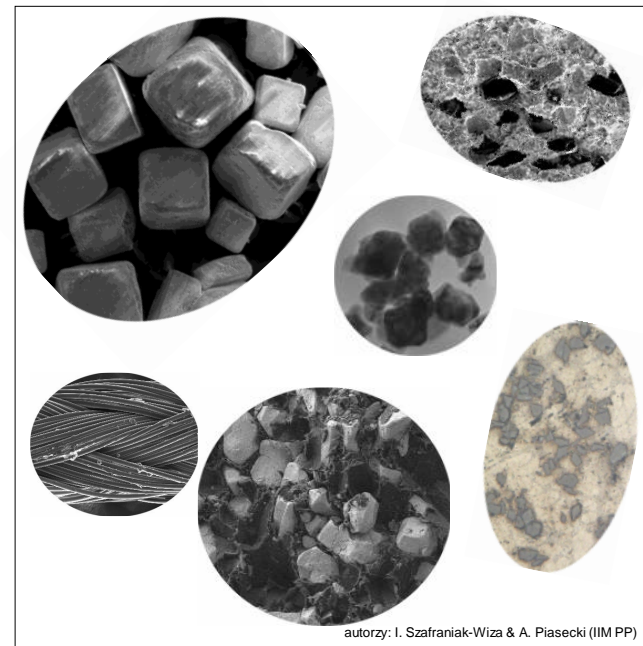


autorzy: I. Szafraniak-Wiza & A. Piasecki (IIM PP)

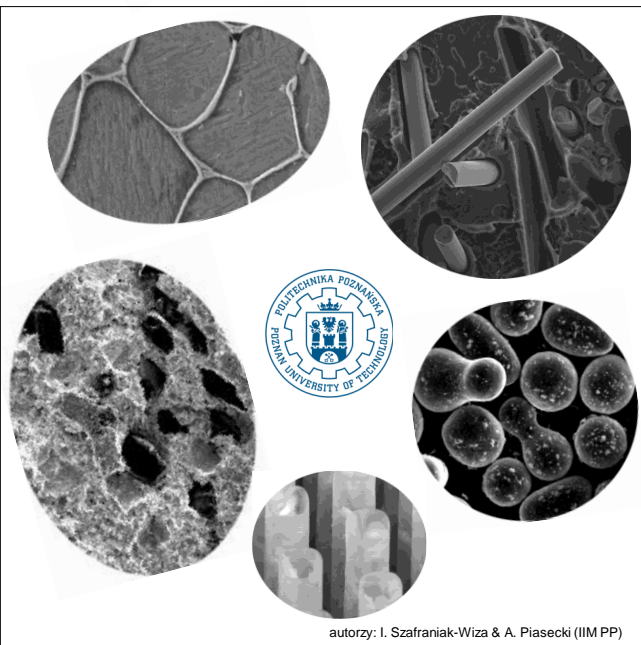


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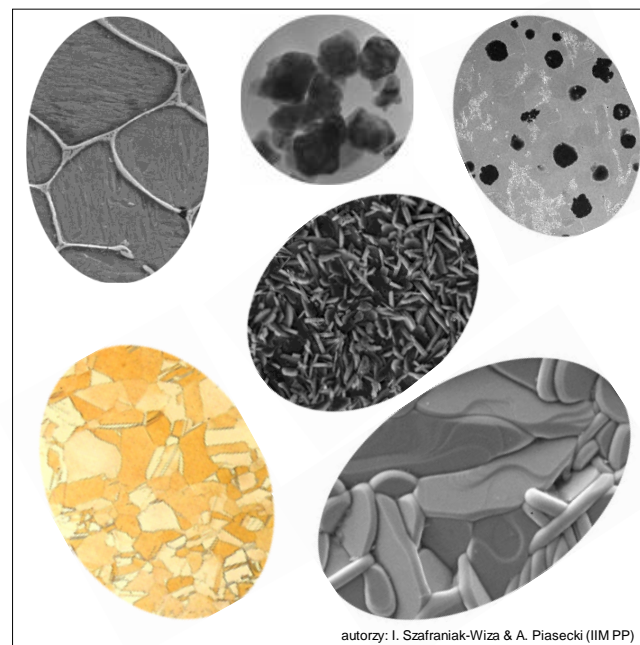
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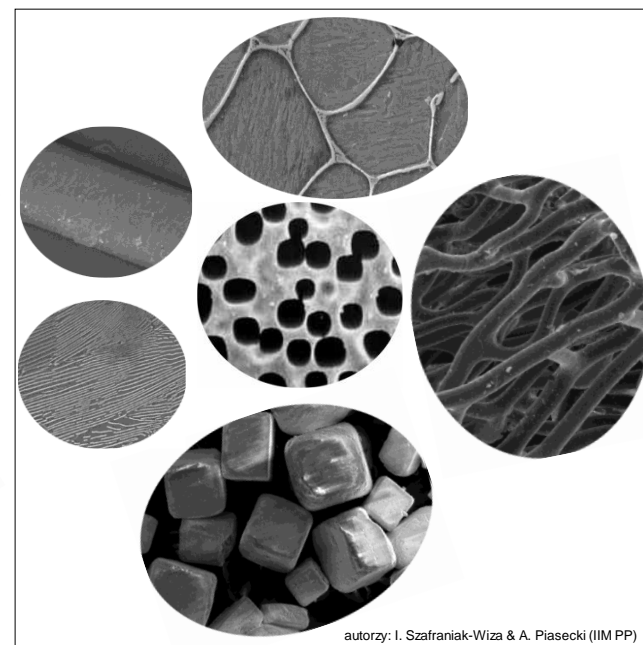
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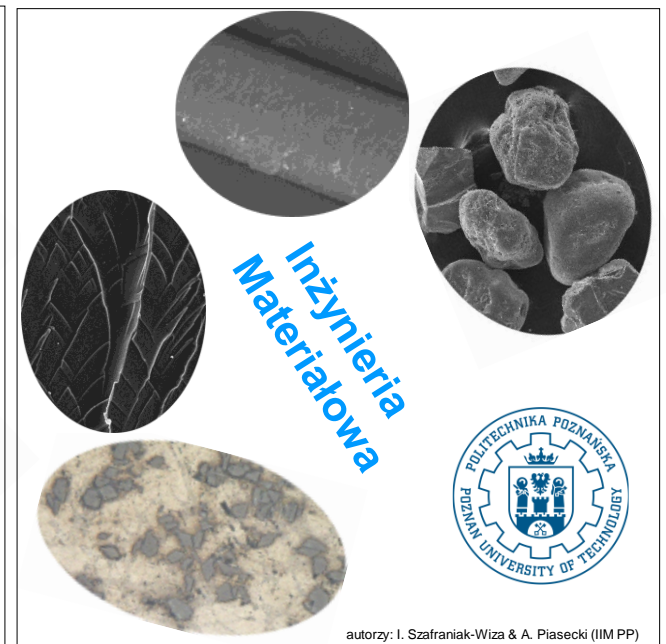
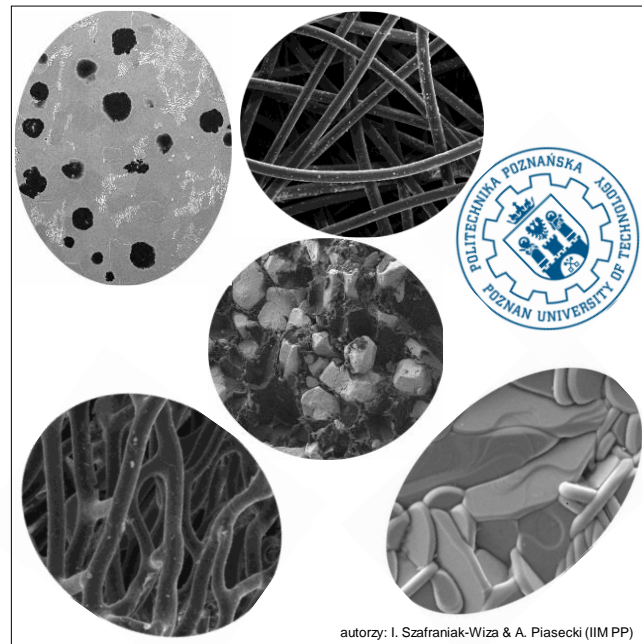
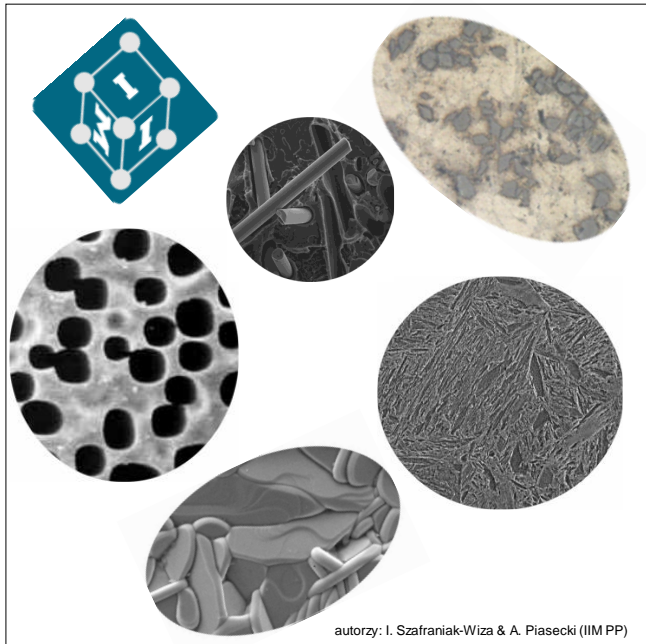
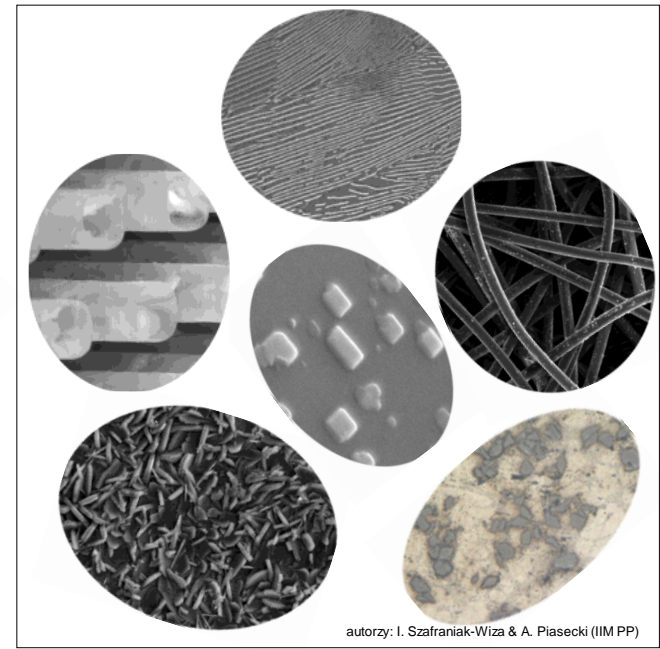
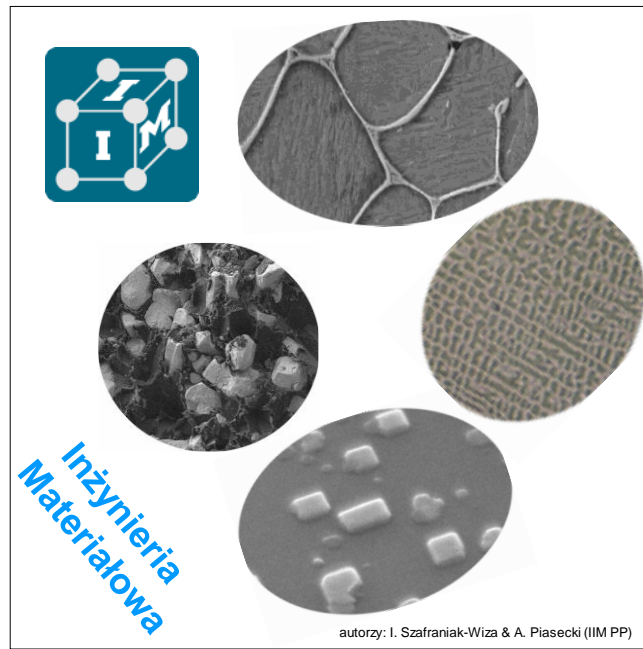
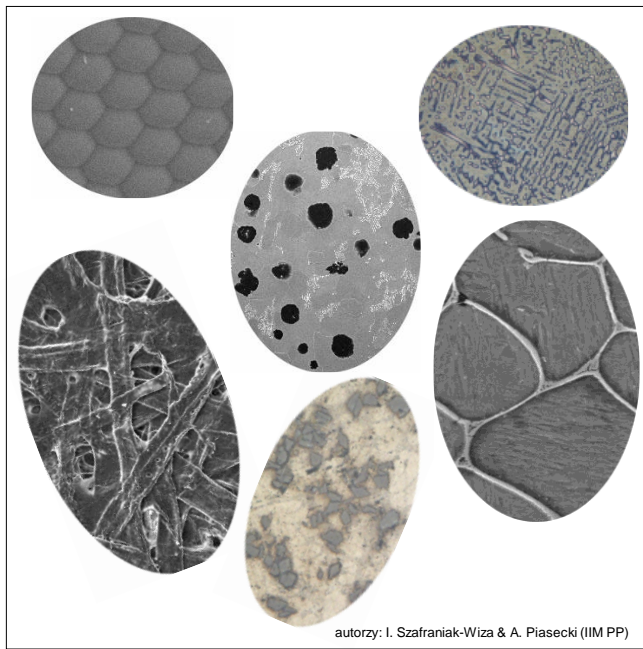
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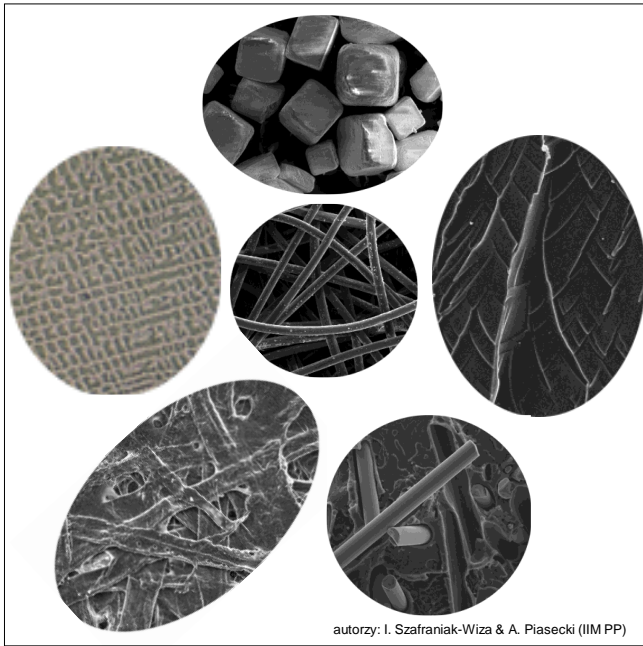


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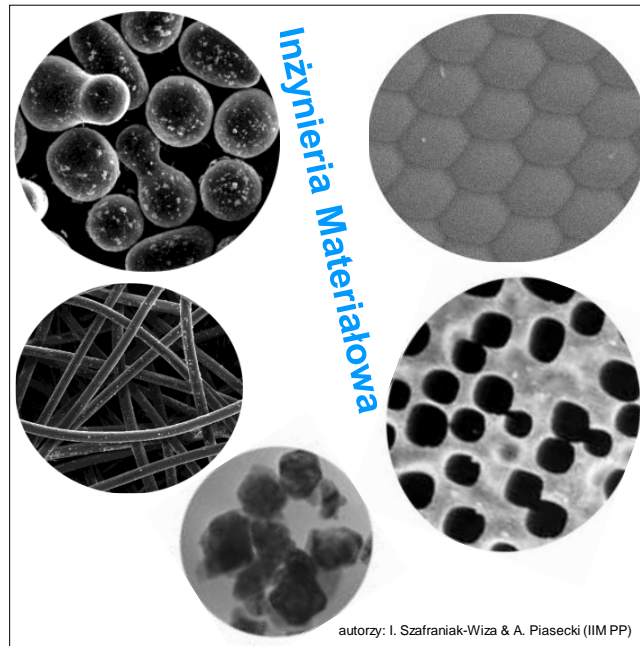


autorzy: I. Szafraniak-Wiza & A. Piasecki (IIM PP)



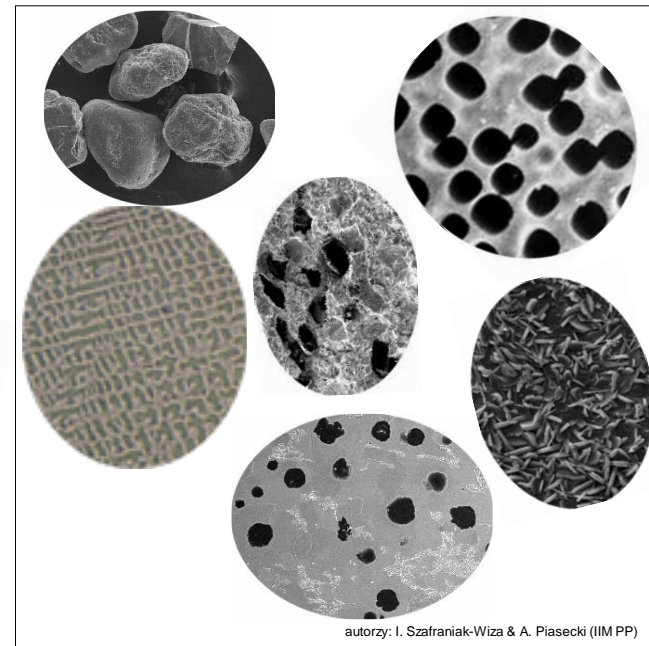


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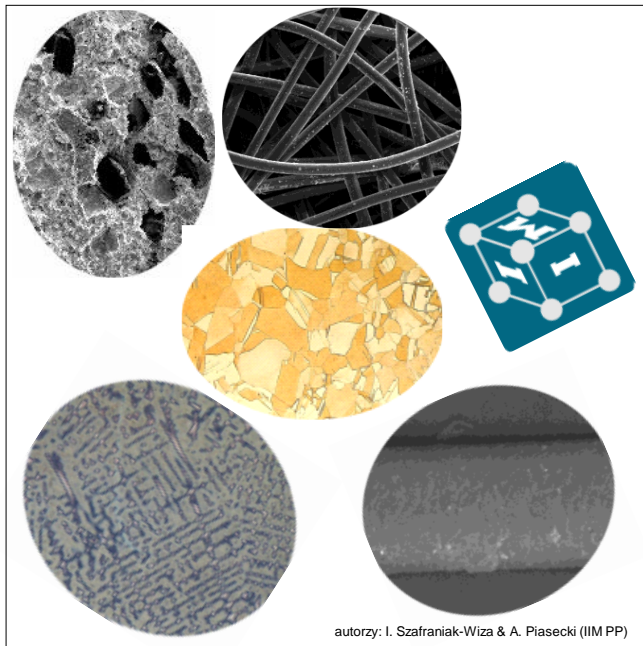


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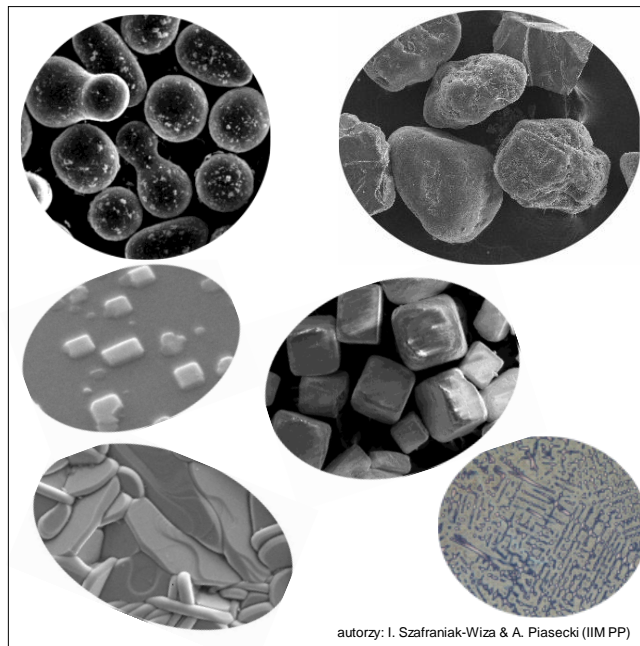
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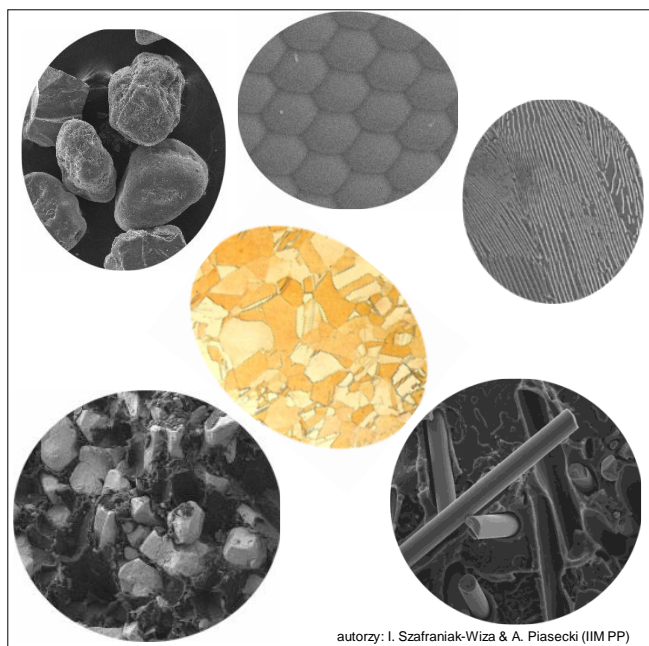
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